

### 3.5x2.8mm SURFACE MOUNT LED LAMP

Part Number: KA-3528LVSECKT-J3 Hyper Red

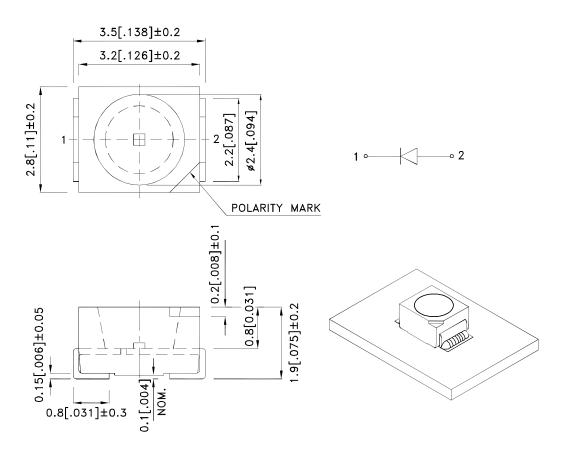
### **Features**

- Single color.
- Suitable for all SMD assembly and solder process.
- Available on tape and reel.
- Ideal for backlighting.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Low current IF=2mA operating.
- RoHS compliant.

### Description

The Hyper Red device is based on light emitting diode chip made from AlGaInP.

### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAO8316 **REV NO: V.1A DATE: JUN/01/2016** PAGE: 1 OF 5 APPROVED: Wynec CHECKED: Allen Liu DRAWN: L.T.Zhang ERP: 1201009173



### **Selection Guide**

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 2mA		Viewing Angle [1]
			Min.	Тур.	201/2
KA 25201 VC5CKT 12	Llymar Dad (AlCalaD)	Water Clear	120	180	- 120°
KA-3528LVSECKT-J3	Hyper Red (AlGaInP)		*30	*50	

### Notes:

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity / luminous Flux: +/-15%.
   Luminous intensity value is traceable to CIE127-2007 standards.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	640		nm	IF=2mA
λD [1]	Dominant Wavelength	Hyper Red	625		nm	IF=2mA
Δλ1/2	Spectral Line Half-width	Hyper Red	20		nm	IF=2mA
С	Capacitance	Hyper Red	27		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	1.8	2.1	V	IF=2mA
lr	Reverse Current	Hyper Red		10	uA	VR=5V

- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

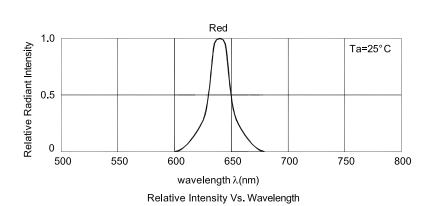
### Absolute Maximum Ratings at TA=25°C

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Parameter	Values	Units			
Power dissipation	105	mW			
DC Forward Current	50	mA			
Peak Forward Current [1]	150	mA			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

- 1.1/10 Duty Cycle, 0.1ms Pulse Width.
   Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

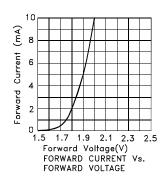
SPEC NO: DSAO8316 **REV NO: V.1A DATE: JUN/01/2016** PAGE: 2 OF 5 ERP: 1201009173 APPROVED: Wynec CHECKED: Allen Liu DRAWN: L.T.Zhang

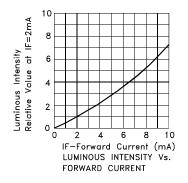
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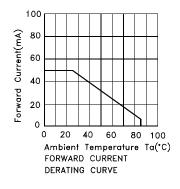


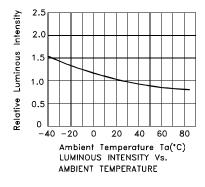
### **Hyper Red**

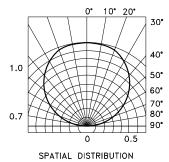
### KA-3528LVSECKT-J3











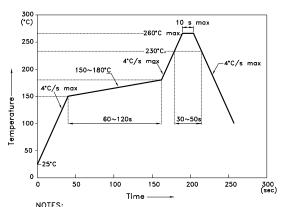
SPEC NO: DSAO8316 REV NO: V.1A DATE: JUN/01/2016 PAGE: 3 OF 5
APPROVED: Wynec CHECKED: Allen Liu DRAWN: L.T.Zhang ERP: 1201009173

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### KA-3528LVSECKT-J3

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



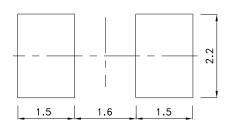
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
  - to high temperature.

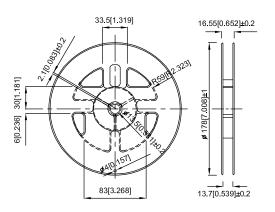
    3.Number of reflow process shall be 2 times or less.

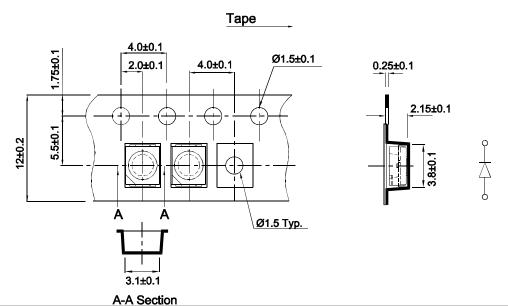
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units : mm)

### **Reel Dimension**





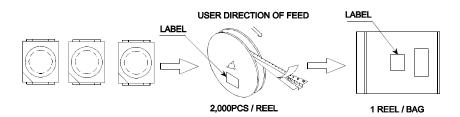
SPEC NO: DSAO8316
APPROVED: Wynec

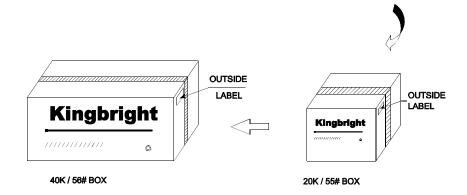
REV NO: V.1A CHECKED: Allen Liu DATE: JUN/01/2016 DRAWN: L.T.Zhang PAGE: 4 OF 5 ERP: 1201009173

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## PACKING & LABEL SPECIFICATIONS

### KA-3528LVSECKT-J3







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SPEC NO: DSAO8316 REV NO: V.1A DATE: JUN/01/2016 PAGE: 5 OF 5

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